



Ai-M62-12F Specification

Version V1.0.1

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1. Product overview

Ai-M62-12F is a Wi-Fi 6 + BLE5.3 module developed by Shenzhen Ai-Thinker Technology Co., Ltd. The module is equipped with BL616 chip as the core processor, supports Wi-Fi 802.11b/g/n/ax protocol and BLE protocol, and supports Thread protocol. The BL616 system includes a low-power 32-bit RISC-V CPU with floating-point unit, DSP unit, cache and memory, with a maximum dominant frequency of 320M.

The Ai-M62-12F module has rich peripheral interfaces, including USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP and GPIO, etc. It can be widely used in audio and video multimedia, Internet of Things (IoT), mobile devices, wearable electronic devices, smart homes and other fields.

The Ai-M62-12F module Sec Eng module supports AES/SHA/PKA/TRNG and other functions, supports image encryption and signature startup, and meets various security application requirements in the Internet of Things field.

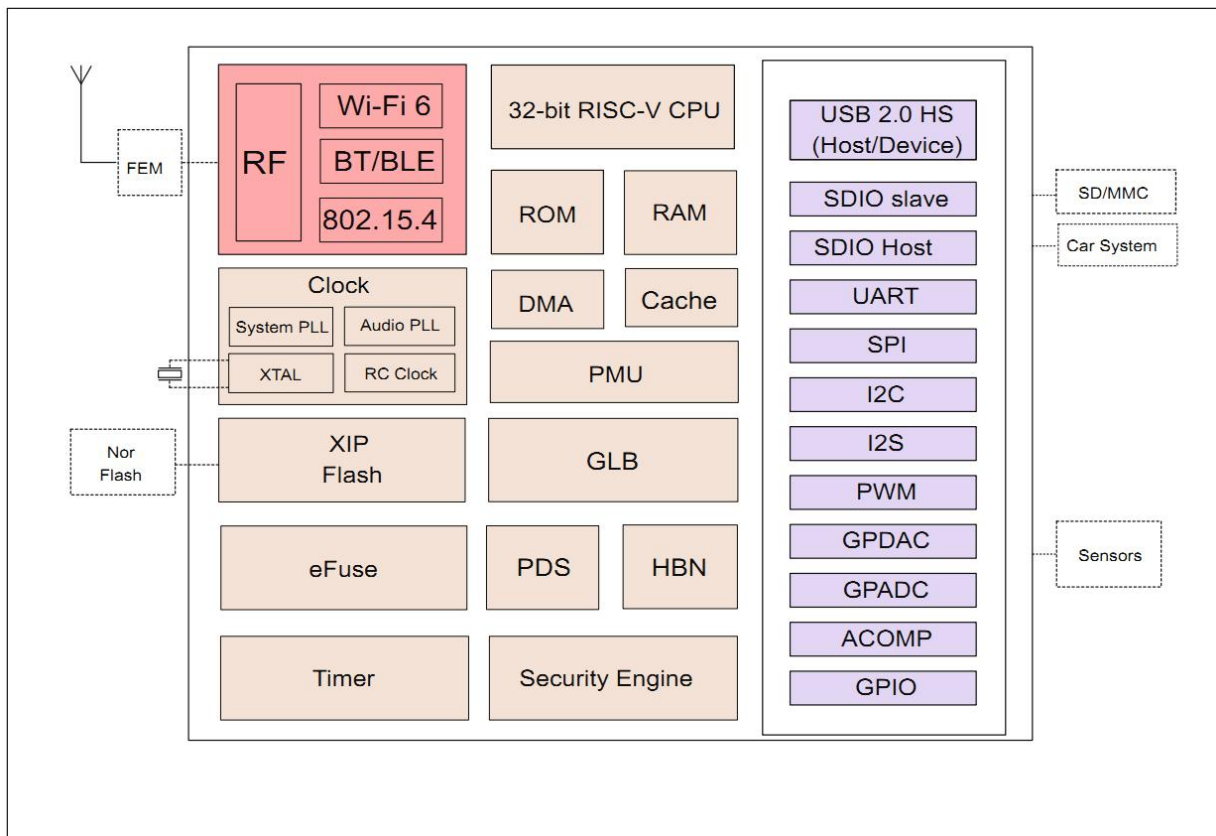


Figure 1 Main chip architecture diagram

1.1. Characteristics

- SMD-22 package
- Supports 2.4GHz operating frequency band
- Support IEEE 802.11 B/g/n/ax
- Support BLE5.3
- Support Thread
- Support Wi-Fi/BLE/Thread coexistence
- Wi-Fi security support WPS/WEP/WPA/WPA2/WPA3
- Supports 20/40MHz bandwidth, 1T1R, maximum rate 229.4 Mbps
- Support STA, SoftAP, STA + SoftAP and sniffer modes
- 32-bit RISC-V CPU with FPU and DSP, with a maximum dominant frequency of 320M
- 532KB SRAM,128KB ROM,4Kb eFuse
- Support USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP and GPIO, etc
- Integrated RF Balun, PA/LNA
- Support for safe startup and safe debugging
- Support XIP QSPI On-The-Fly AES decryption (OTFAD)
- Support TrustZone
- Support AES-CBC/CCM/GCM/XTS mode
- Support MD5, SHA-1/224/256/384/512
- TRNG (True Random Number Generator) is supported
- Support PKA (Public Key Accelerator) for RSA/ECC
- BLE-enabled Wi-Fi fast connection
- Universal AT command can be used quickly.
- Supports secondary development and integrates Windows and Linux development environments

2. Main parameters

Table 1 Description of Main Parameters

Model	Ai-M62-12F
Package	SMD-22
Size	24.0*16.0*3.1(±0.2)mm
Antenna	onboard antenna
Frequency	2400~2483.5MHz
Operating temperature	-40 °C ~ 85 °C
Storage temperature	-40°C ~ 125°C, < 90%RH
Power supply	The power supply voltage is 2.97V ~ 3.6V, and the power supply current is ≥ 500mA.
Interface	USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP and GPIO, etc
IO	15
UART rate	Default 115200 bps
Security	WPS/WEP/WPA/WPA2/WPA3
Flash	Default 4MByte, maximum support of 16MByte

2.1. Electrostatic requirements

Ai-M62-12F are electrostatic sensitive equipment, special precautions need to be taken when handling.



Figure 2 ESD preventive measures

2.2. Electrical characteristics

Table 2 Table of Electrical Characteristics

Parameters	Condition	Min.	Typical value	Max.	Unit
Supply voltage	VDD	2.97	3.3	3.6	V
I/O	VIL	-	-	0.3*VDDIO	V
	VIH	-	0.7*VDDIO	-	V
	VOL	-	-	0.1*VDDIO	V
	VOH	-	-	0.9*VDDIO	V
	IMAX	-	-	-	15

2.3. Wi-Fi radio frequency performance

Table 3 Wi-Fi RF Performance table

Description	Typical value			Unit
Spectrum range	2400~2483.5MHz			MHz
Output power				
Mode	Min.	Typical value	Max.	Unit
11ax mode HE40,PA output power	-	16	-	dBm
11ax mode HE20,PA output power	-	17	-	dBm
11n mode HT40,PA output power	-	19	-	dBm
11n mode HT20,PA output power	-	19	-	dBm
In 11g mode, PA output power	-	19	-	dBm
In 11b mode, PA output power	-	22	-	dBm
Receiving sensitivity				
Mode	Min.	Typical value	Max.	Unit
11b,1 Mbps	-	-98	-	dBm
11b,11 Mbps	-	-90	-	dBm
11g,6 Mbps	-	-93	-	dBm
11g,54 Mbps	-	-76	-	dBm
11n,HT20 (MCS7)	-	-73	-	dBm
11ax,HE20 (MCS9)	-	-70	-	dBm
11ax,HE40 (MCS9)	-	-67	-	dBm

2.4. BLE RF performance

Table 4 BLE RF Performance table

Description	Typical value			Unit
Spectrum range	2400~2483.5MHz			MHz
Output power				
Mode	Min.	Typical value	Max.	Unit
1Mbps	-	10	15	dBm
2Mbps	-	10	15	dBm
Receiving sensitivity				
Mode	Min.	Typical value	Max.	Unit
1Mbps sensitivity @ 30.8%PER	-	-99	-	dBm
2Mbps sensitivity @ 30.8%PER	-	-97	-	dBm

2.5. Power consumption

The following power consumption data is based on a 3.3V power supply and measured at an ambient temperature of 25°C.

- The POUT power for all transmit modes is the measured value at the antenna interface.
- All transmission data are measured in the continuous transmission mode based on a duty cycle of 100%.

Table 5 Power consumption table

Mode	Min.	Average	Max.	Unit
Transmit 802.11B, 11Mbps, POUT = + 22dBm	-	442	-	mA
Transmit 802.11g, 54Mbps, POUT = + 19dBm	-	296	-	mA
Emission 802.11n, MCS7, POUT = + 19dBm	-	301	-	mA
Launch 802.11ax, MCS9, POUT = + 17dBm	-	269	-	mA
Receive 802.11B, packet length 1024 bytes	-	59	-	mA
Receive 802.11g, packet length 1024 bytes	-	59	-	mA
Receive 802.11n, packet length 1024 bytes	-	59	-	mA
Receive 802.11ax, packet length 1024 bytes	-	59	-	mA

3. Appearance size

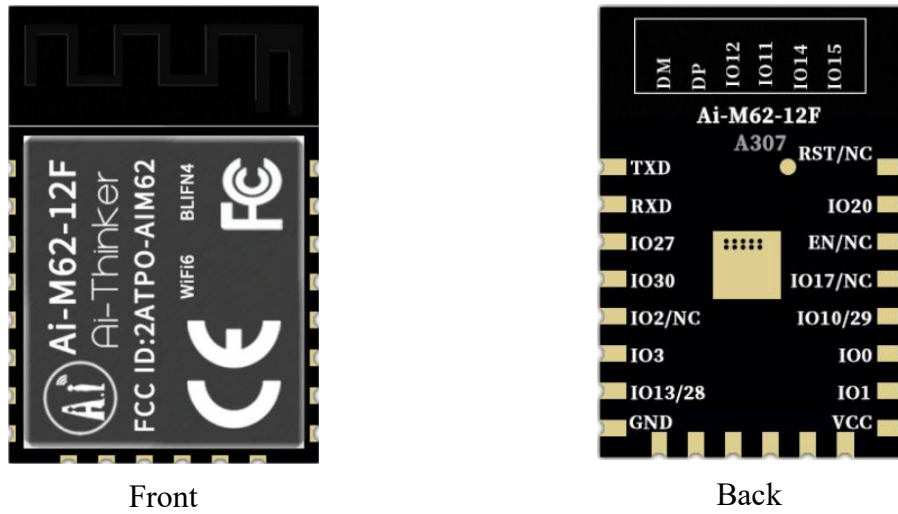


Figure 3 appearance diagram (Rendering diagram is for reference only, subject to actual objects)

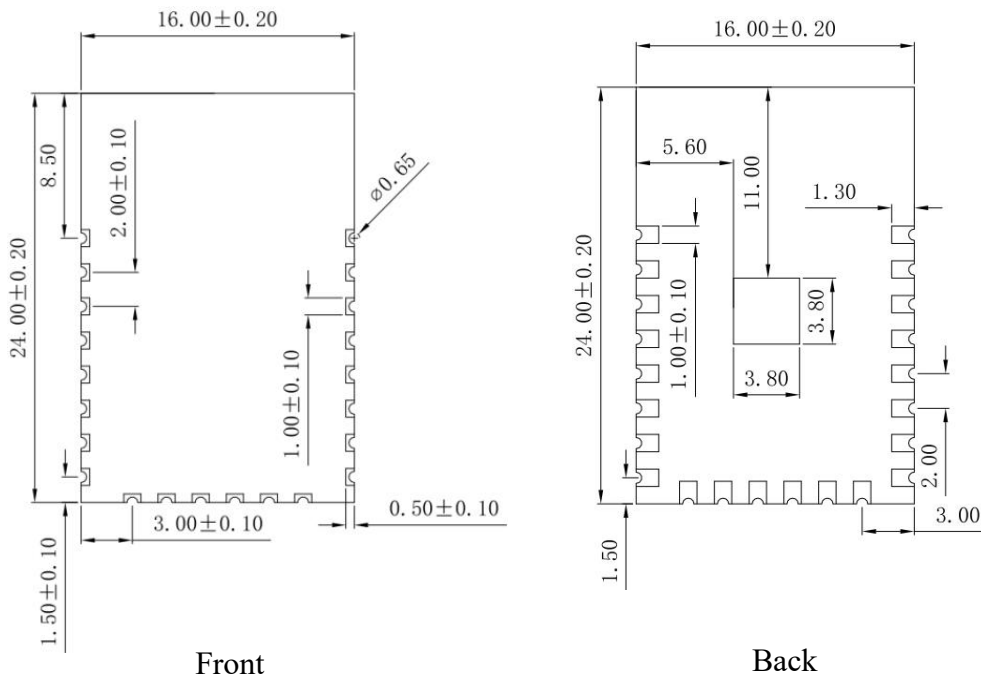


Figure 4 dimension diagram

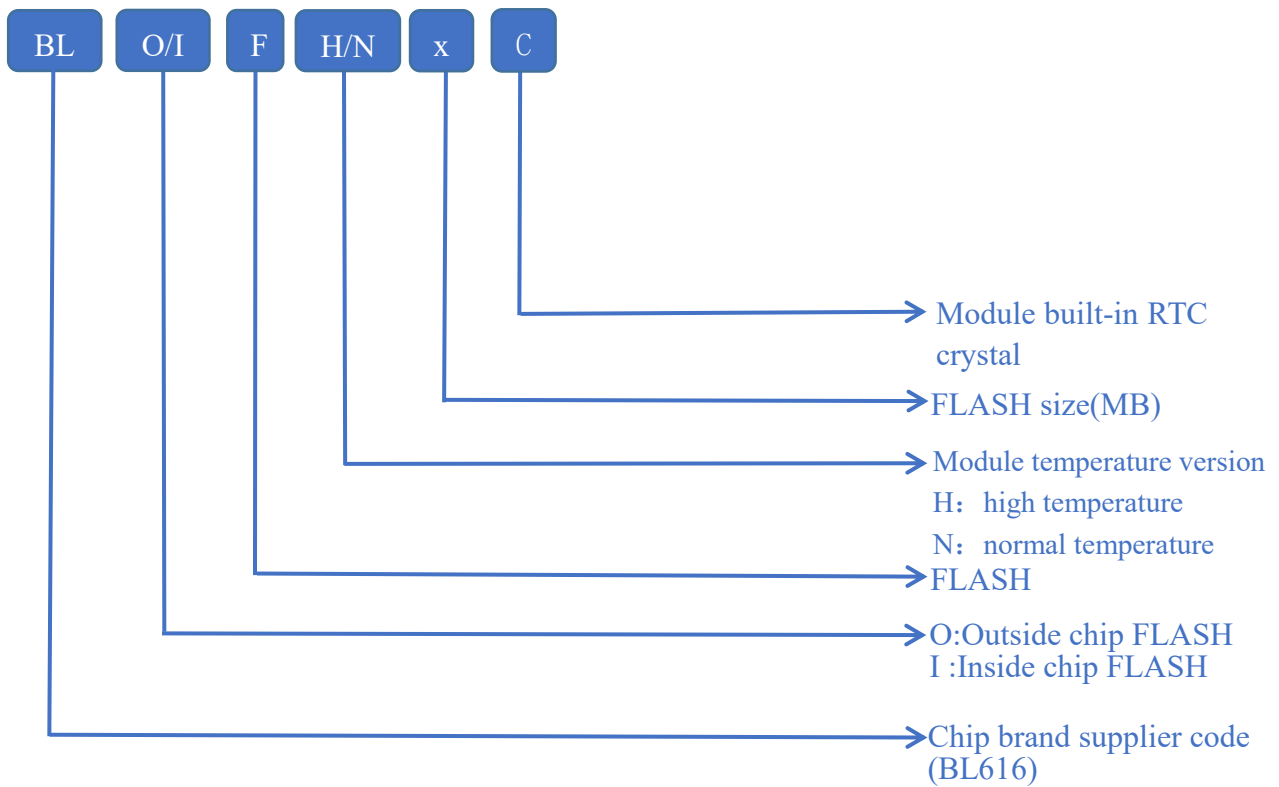


Figure 5 Screen Screen Representative Information of Shields

4. Pin definition

A total of 22 pins are connected to the Ai-M62-12F module, as shown in the pin diagram, the pin function definition table is an interface definition.

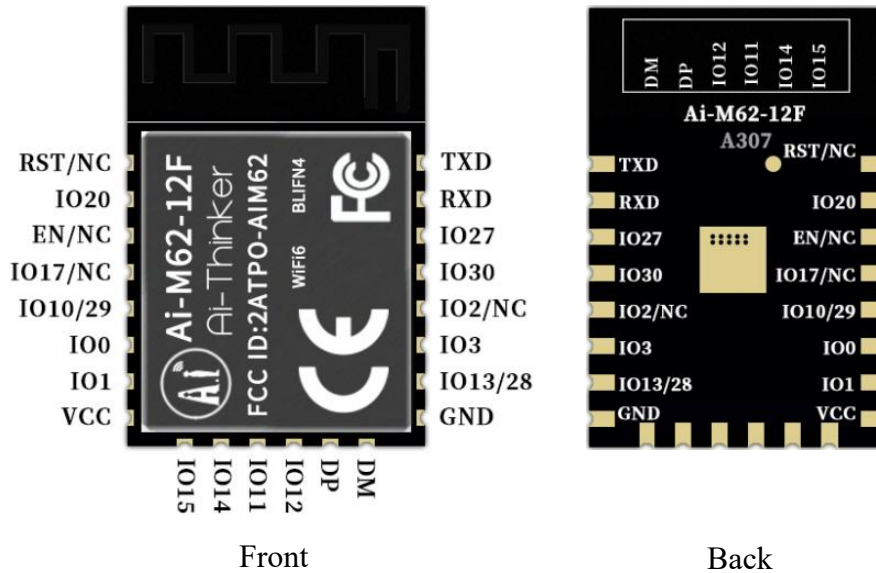


Figure 6 pin diagram

Table 6 Pin Function Definition table

No.	Name	Functional description
1	RST/NC	The default is floating, and it can be customized as a reset pin, which is active at low level. If you need to use it, please contact Ai-Thinker
2	IO20	GPIO20/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH0/PWM0
3	EN/NC	By default, it is enabled as a chip, active at high level, and cannot be used at the same time as RST
4	IO17/NC	Available by default, the IO port is shared with the 32.768KHz crystal output PIN pin inside the module. If the module of the internal patch 32.768KHz crystal oscillator is customized, the IO is in NC state. GPIO17/SPI_SCLK/I2S_FS/I2C_SDA/XTAL_32K_OUT/PWM0
5	IO10/29	The default is IO29,GPIO29/SPI_SCLK/I2S_FS/I2C_SDA/PWM0
6	IO0	GPIO0/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH9/PWM0
7	IO1	GPIO1/SPI_SCLK/I2S_FS/I2C_SDA/ADC_CH8/PWM0
8	VCC	3.3V power supply; The output current of external power supply is recommended to be above 500mA
9	IO15	Available by default, this IO port is shared with Flash in the module. If a module with external Flash is customized, the IO is not available. For use, please contact Ai-Thinker. GPIO15/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/PWM0

10	IO14	Available by default, this IO port is shared with Flash in the module. If a module with external Flash is customized, the IO is not available. For use, please contact Ai-Thinker. GPIO14/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/ADC_CH4/PWM0
11	IO11	Available by default, this IO port is shared with Flash in the module. If a module with external Flash is customized, the IO is not available. For use, please contact Ai-Thinker. GPIO11/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/PWM0
12	IO12	Available by default, this IO port is shared with Flash in the module. If a module with external Flash is customized, the IO is not available. For use, please contact Ai-Thinker. GPIO12/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH6/PWM0
13	DP	USB_DP
14	DM	USB_DM
15	GND	Grounding
16	IO13/28	The default is IO28,GPIO28/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH11/PWM0
17	IO3	GPIO3/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/ADC_CH3/PWM0
18	IO2/NC	The default NC is not available. If you need to use it, please contact Ai-Thinker. If elicited, support Bootstrap/GPIO2/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/ADC_CH2/PWM0
19	IO30	GPIO30/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/PWM0
20	IO27	GPIO27/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/ADC_CH10/PWM0
21	RXD	RXD/GPIO22/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/PWM0
22	TXD	TXD/GPIO21/SPI_SCLK/I2S_FS/I2C_SDA/ADC_RCAL_VOUT/PWM0
<p>Note: 1. GPIO2 is used as a Bootstrap. When the power-on moment is high, the module enters the burning mode. When the power-on moment is low, the module starts normally.</p>		

5. Schematic diagram

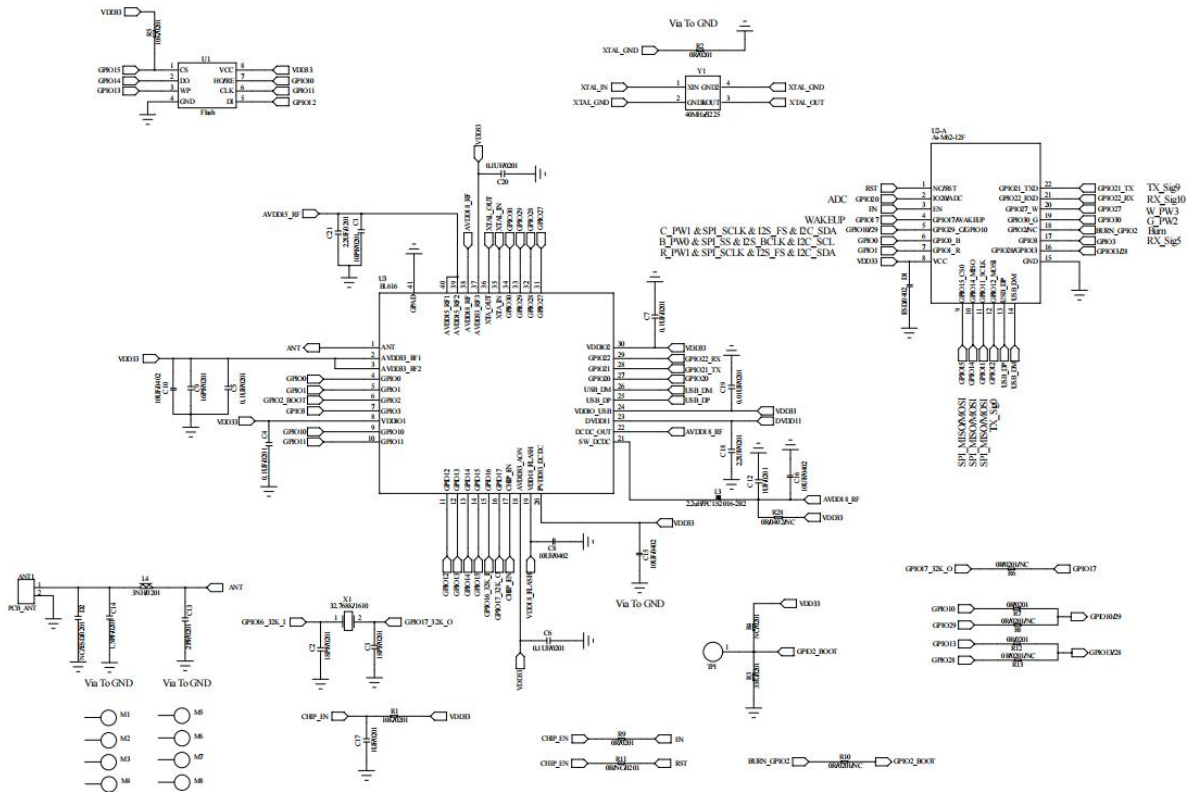


Figure 7 Schematic Diagram

6. Antenna parameters

6.1. Schematic of Antenna Test Prototype

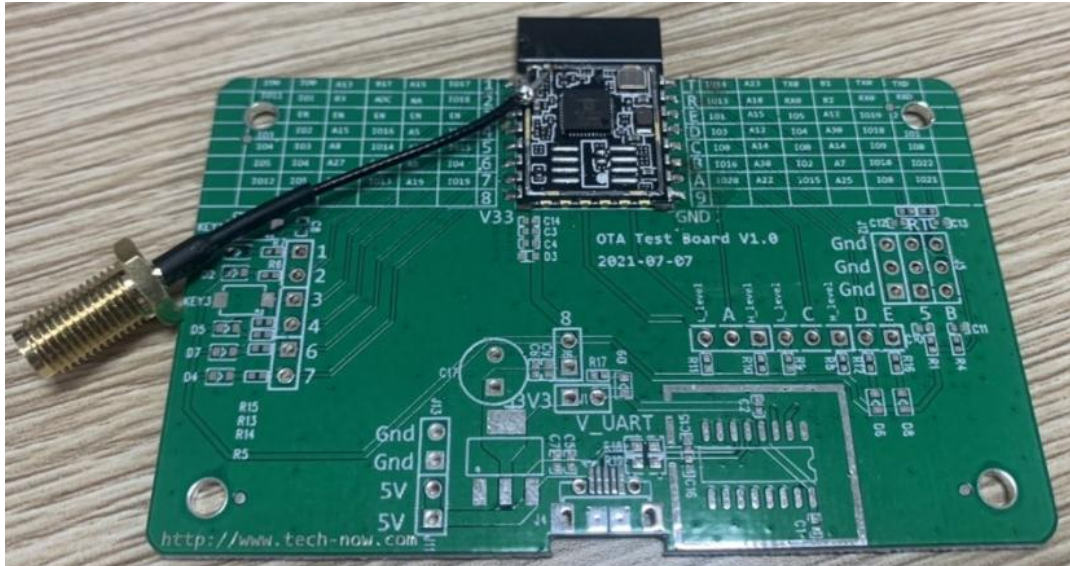


Figure 8 schematic diagram of antenna test prototype

6.2. Antenna s parameter

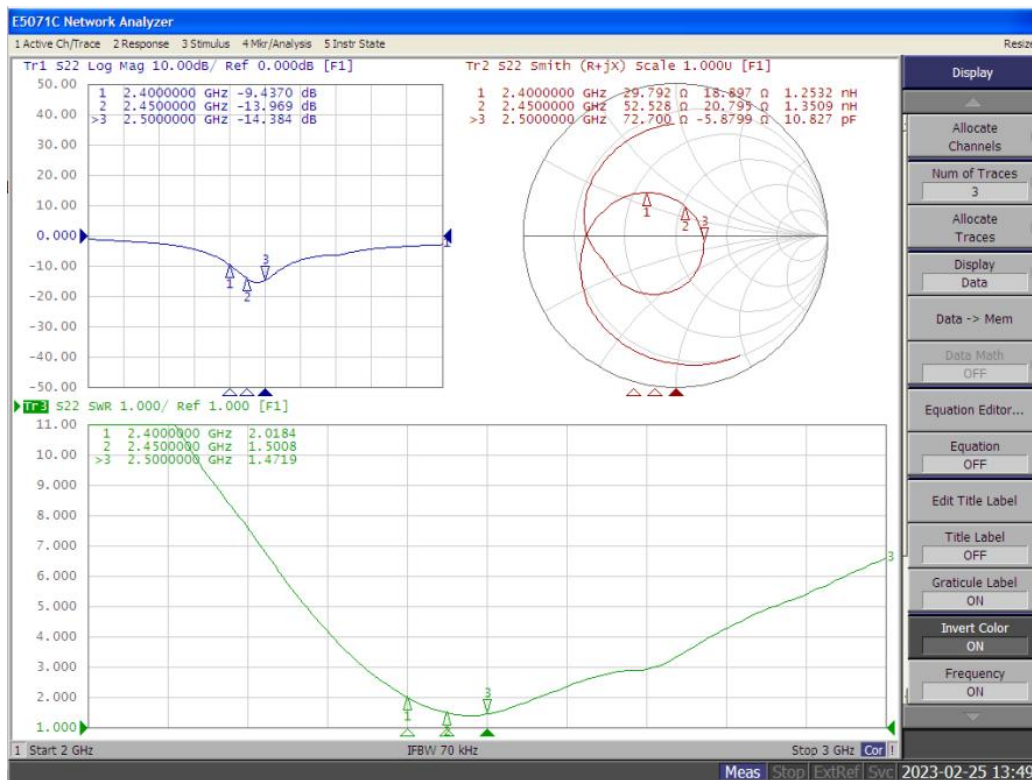


Figure 9 antenna s parameters

6.3. Antenna Gain and Efficiency

Table 7 Antenna Gain and Efficiency

Frequency ID	1	2	3	4	5	6	7	8	9	10	11
Frequency(MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	0.15	0.35	0.33	0.54	0.93	1.00	1.21	1.32	1.18	1.14	1.23
Efficiency (%)	46.44	48.21	46.87	48.02	51.00	51.53	54.15	55.61	54.13	53.62	54.38

6.4. Antenna field pattern

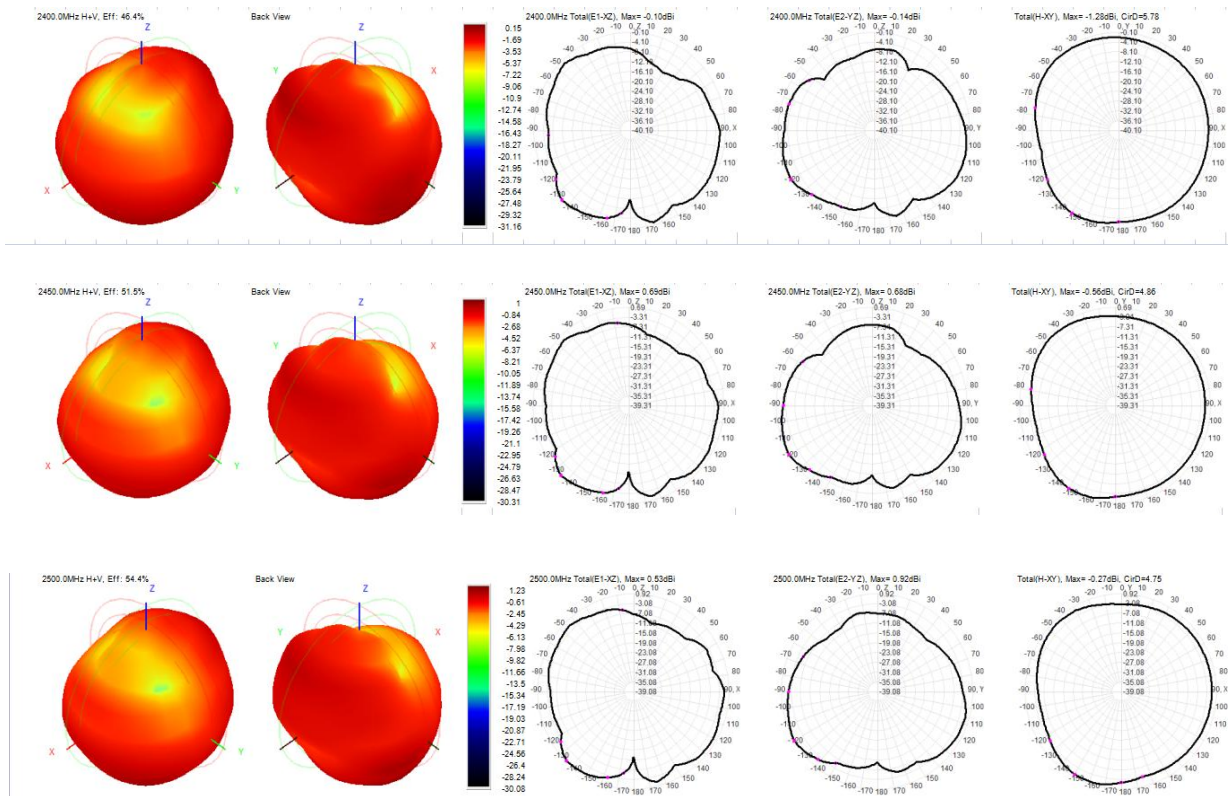


Figure 10 antenna field diagram

7.2. Recommended PCB package size

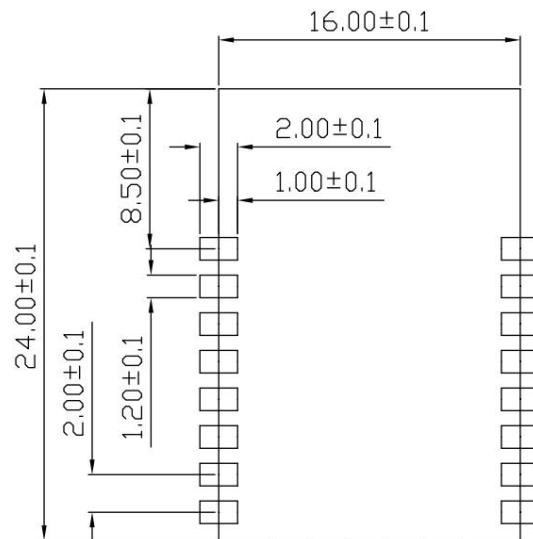


Figure 12 Recommended PCB Package Size

7.3. Antenna layout requirements

- In the installation position on the motherboard, the following 2 methods are recommended:

Scheme 1: Place the module on the edge of the main board, and the antenna area extends out of the edge of the main board.

Scheme 2: Place the module on the edge of the motherboard, and the edge of the motherboard hollowed out an area at the antenna position.

- In order to meet the performance of the on-board antenna, it is forbidden to place metal parts around the antenna, away from high-frequency devices.

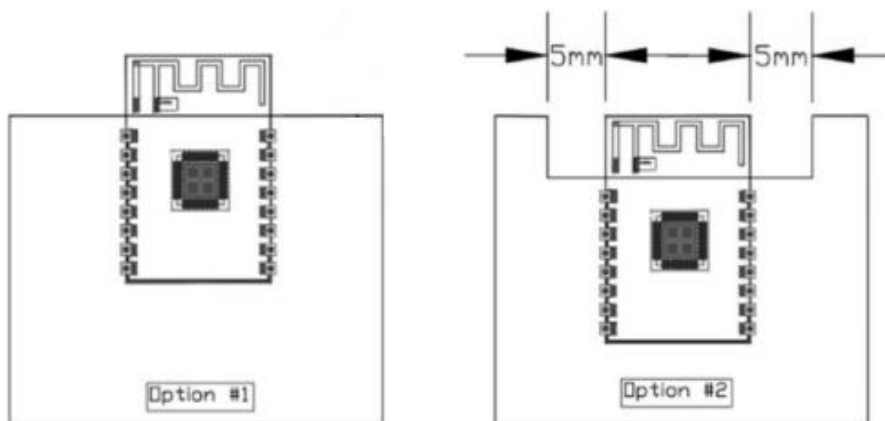


Figure 13 schematic diagram of antenna layout

7.4. Power supply

- Recommended 3.3V voltage, peak current above 500mA.
- LDO is recommended for power supply; If DC-DC is used, it is recommended that the ripple be controlled within 30mV.
- The DC-DC power supply circuit suggests to reserve the position of the dynamic response capacitor, which can optimize the output ripple when the load changes greatly.
- It is recommended to add ESD devices to the 3.3V power interface.

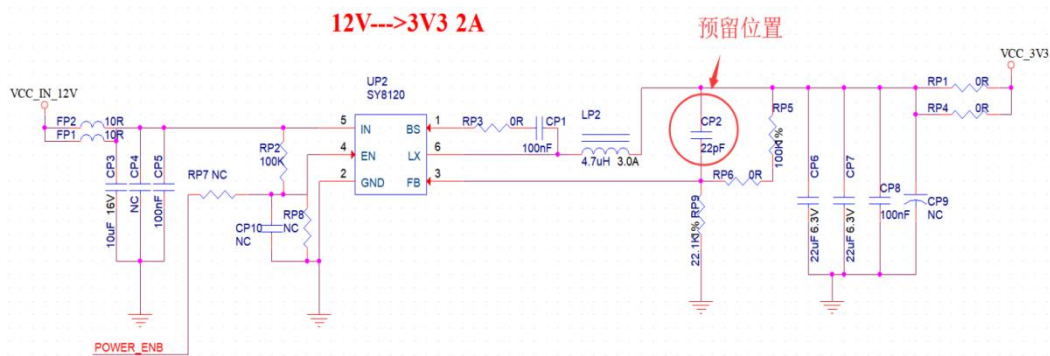


Figure 14 DC-DC step-down circuit diagram

7.5. GPIO

- Some IO ports are led out from the periphery of the module. If you need to use a resistor of 10-100 ohms in series on the IO port. This can suppress overshoot and make the level on both sides more stable. It is helpful for both EMI and ESD.
- For the up and down of the special IO port, please refer to the instructions in the specification, which will affect the startup configuration of the module.
- The IO port of the module is 3.3V. If the level of the IO port of the main control and the module does not match, a level conversion circuit needs to be added.
- If the IO port is directly connected to the peripheral interface or terminals such as pins, it is recommended to reserve ESD devices at the IO port wiring close to the terminals.

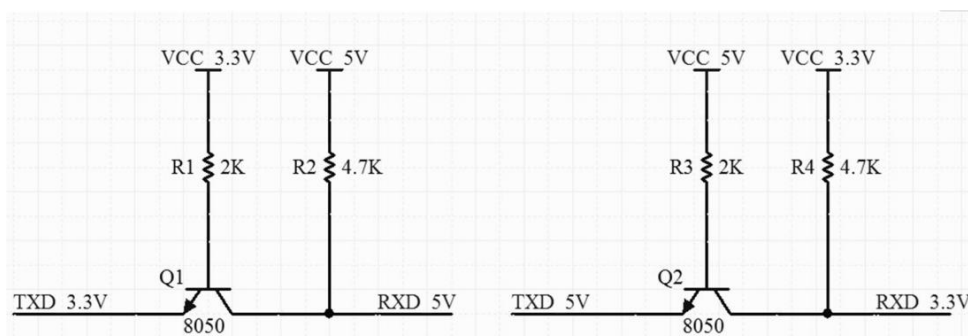


Figure 15 Level Shift Circuit

8. Storage conditions

The product sealed in the moisture-proof bag should be stored in a non-condensing atmospheric environment of $<40^{\circ}\text{C}/90\%\text{RH}$.

The moisture sensitivity level MSL of the module is level 3.

After the vacuum bag is unpacked, it must be used within 168 hours at $25 \pm 5^{\circ}\text{C}/60\%\text{RH}$, otherwise it needs to be baked before it can be put on line again.

9. Reflow Soldering Curve

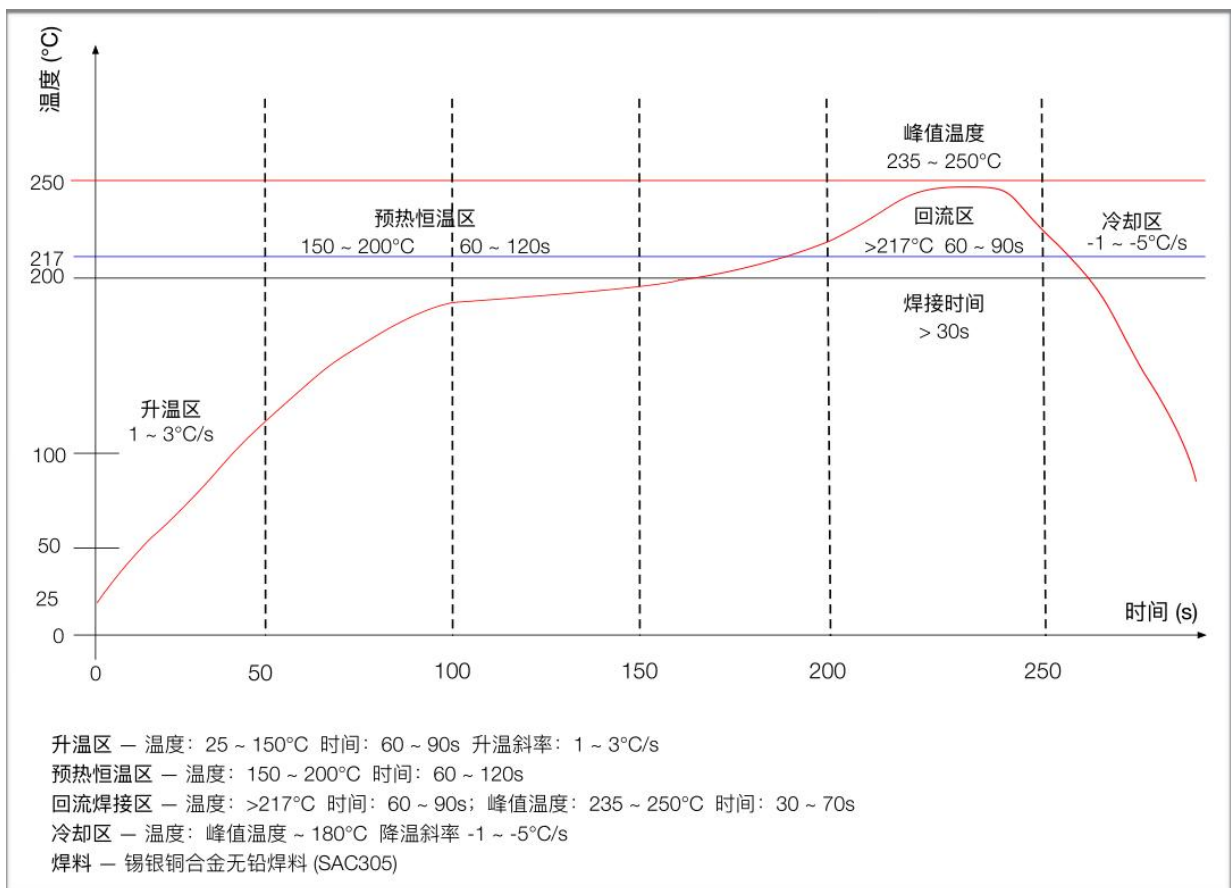


Figure 16 reflow soldering graph

10. Product packaging information

The Ai-M62-12F module adopts braided packaging, 800 pcs/disk. As shown in the following figure:

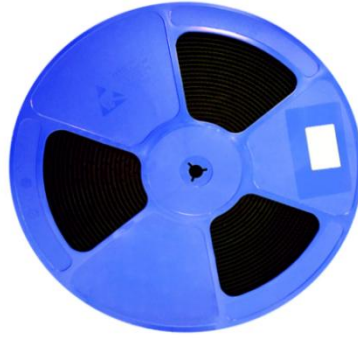


Figure 17 packing tape drawing

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